

# SN74CB3T3383

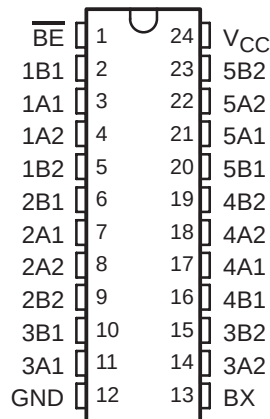
## 10-BIT FET BUS-EXCHANGE SWITCH

### 2.5-V/3.3-V LOW-VOLTAGE BUS SWITCH WITH 5-V-TOLERANT LEVEL SHIFTER

SCDS158A – OCTOBER 2003 – REVISED DECEMBER 2004

- Output Voltage Translation Tracks  $V_{CC}$
- Supports Mixed-Mode Signal Operation On All Data I/O Ports
  - 5-V Input Down To 3.3-V Output Level Shift With 3.3-V  $V_{CC}$
  - 5-V/3.3-V Input Down To 2.5-V Output Level Shift With 2.5-V  $V_{CC}$
- 5-V-Tolerant I/Os With Device Powered Up or Powered Down
- Bidirectional Data Flow, With Near-Zero Propagation Delay
- Low ON-State Resistance ( $r_{on}$ ) Characteristics ( $r_{on} = 5\ \Omega$  Typical)
- Low Input/Output Capacitance Minimizes Loading ( $C_{io(OFF)} = 8\text{ pF}$  Typical)
- Data and Control Inputs Provide Undershoot Clamp Diodes
- Low Power Consumption ( $I_{CC} = 20\ \mu\text{A}$  Max)
- $V_{CC}$  Operating Range From 2.3 V to 3.6 V
- Data I/Os Support 0- to 5-V Signaling Levels (0.8 V, 1.2 V, 1.5 V, 1.8 V, 2.5 V, 3.3 V, 5 V)
- Control Inputs Can Be Driven by TTL or 5-V/3.3-V CMOS Outputs
- $I_{off}$  Supports Partial-Power-Down Mode Operation
- Latch-Up Performance Exceeds 250 mA Per JESD 17
- ESD Performance Tested Per JESD 22
  - 2000-V Human-Body Model (A114-B, Class II)
  - 1000-V Charged-Device Model (C101)
- Supports Digital Applications: Level Translation, Memory Interleaving, Bus Isolation
- Ideal for Low-Power Portable Equipment

DBQ, DGV, DW, OR PW PACKAGE  
(TOP VIEW)



#### description/ordering information

#### ORDERING INFORMATION

| $T_A$         | PACKAGE <sup>†</sup> |               | ORDERABLE PART NUMBER | TOP-SIDE MARKING |
|---------------|----------------------|---------------|-----------------------|------------------|
| -40°C to 85°C | SOIC – DW            | Tube          | SN74CB3T3383DW        | CB3T3383         |
|               |                      | Tape and reel | SN74CB3T3383DWR       |                  |
|               | SSOP (QSOP) – DBQ    | Tape and reel | SN74CB3T3383DBQR      | CB3T3383         |
|               | TSSOP – PW           | Tube          | SN74CB3T3383PW        | KS383            |
|               |                      | Tape and reel | SN74CB3T3383PWR       |                  |
|               | TVSOP – DGV          | Tape and reel | SN74CB3T3383DGV       | KS383            |

<sup>†</sup> Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at [www.ti.com/sc/package](http://www.ti.com/sc/package).



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.



POST OFFICE BOX 655303 • DALLAS, TEXAS 75265

Copyright © 2004, Texas Instruments Incorporated

# SN74CB3T3383

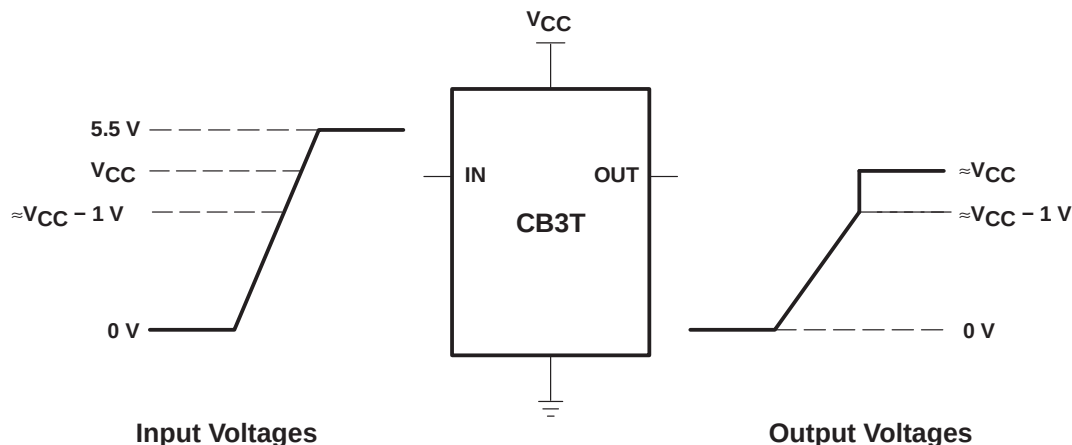
## 10-BIT FET BUS-EXCHANGE SWITCH

### 2.5-V/3.3-V LOW-VOLTAGE BUS SWITCH WITH 5-V-TOLERANT LEVEL SHIFTER

SCDS158A – OCTOBER 2003 – REVISED DECEMBER 2004

#### description/ordering information (continued)

The SN74CB3T3383 is a high-speed TTL-compatible FET bus-exchange switch with low ON-state resistance ( $r_{ON}$ ), allowing for minimal propagation delay. The device fully supports mixed-mode signal operation on all data I/O ports by providing voltage translation that tracks  $V_{CC}$ . The SN74CB3T3383 supports systems using 5-V TTL, 3.3-V LVTTTL, and 2.5-V CMOS switching standards, as well as user-defined switching levels (see Figure 1).



NOTE A: If the input high voltage ( $V_{IH}$ ) level is greater than or equal to  $V_{CC} - 1\text{ V}$ , and less than or equal to 5.5 V, then the output high voltage ( $V_{OH}$ ) level will be equal to approximately the  $V_{CC}$  voltage level.

**Figure 1. Typical DC Voltage Translation Characteristics**

The SN74CB3T3383 is organized as a 10-bit bus switch or as a 5-bit bus-exchange with enable ( $\overline{BE}$ ) input. When used as a 5-bit bus-exchange, the device provides data exchanging between four signal ports. When  $\overline{BE}$  is low, the bus-exchange switch is ON, and the select input (BX) controls the data path. When  $\overline{BE}$  is high, the bus-exchange switch is OFF, and a high-impedance state exists between the A and B ports.

This device is fully specified for partial-power-down applications using  $I_{off}$ . The  $I_{off}$  feature ensures that damaging current will not backflow through the device when it is powered down. The device has isolation during power off.

To ensure the high-impedance state during power up or power down,  $\overline{BE}$  should be tied to  $V_{CC}$  through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

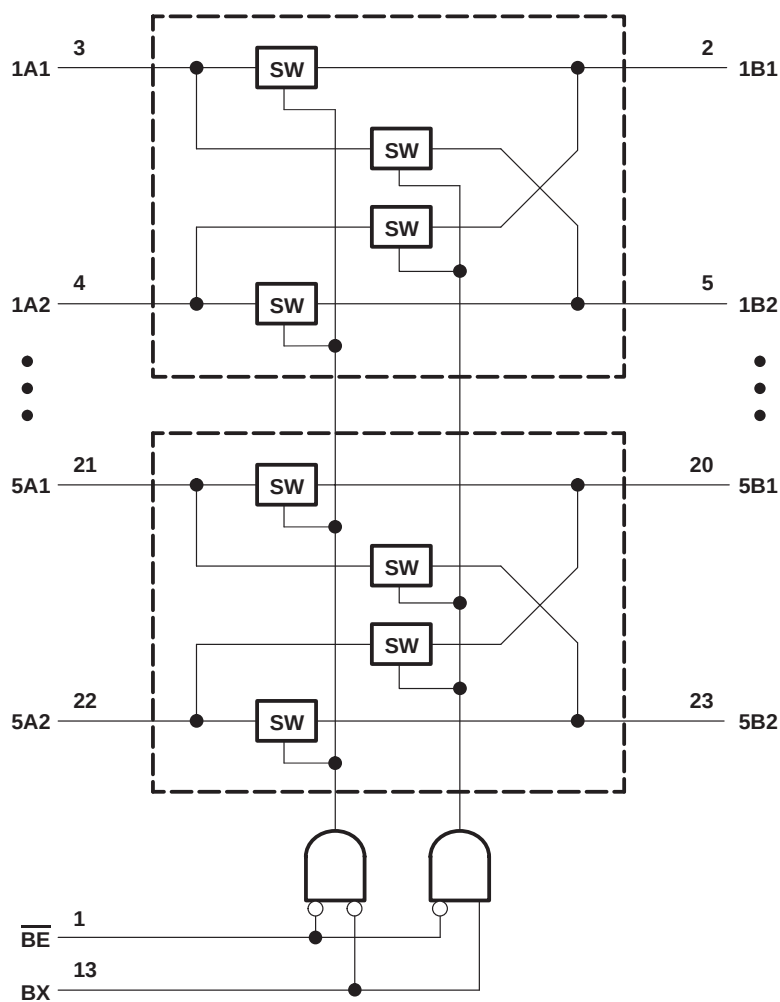
**SN74CB3T3383**  
**10-BIT FET BUS-EXCHANGE SWITCH**  
**2.5-V/3.3-V LOW-VOLTAGE BUS SWITCH WITH 5-V-TOLERANT LEVEL SHIFTER**

SCDS158A – OCTOBER 2003 – REVISED DECEMBER 2004

FUNCTION TABLE  
(each 5-bit switch)

| INPUTS                 |    | INPUTS/OUTPUTS |    | FUNCTION                               |
|------------------------|----|----------------|----|----------------------------------------|
| $\overline{\text{BE}}$ | BX | A1             | A2 |                                        |
| L                      | L  | B1             | B2 | A1 port = B1 port<br>A2 port = B2 port |
| L                      | H  | B2             | B1 | A1 port = B2 port<br>A2 port = B1 port |
| H                      | X  | Z              | Z  | Disconnect                             |

logic diagram (positive logic)



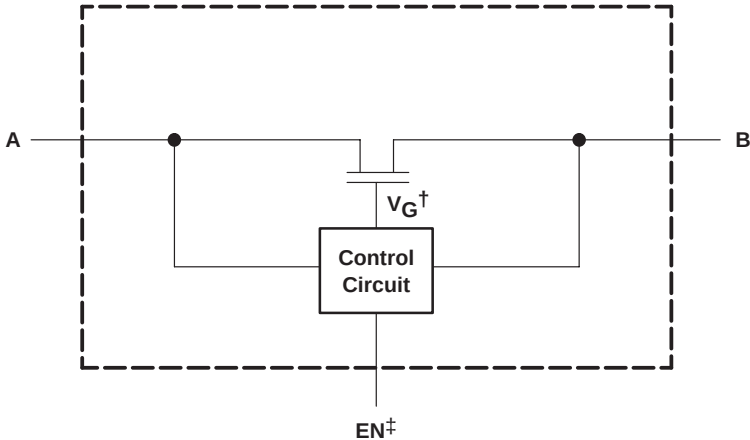
SN74CB3T3383

10-BIT FET BUS-EXCHANGE SWITCH

2.5-V/3.3-V LOW-VOLTAGE BUS SWITCH WITH 5-V-TOLERANT LEVEL SHIFTER

SCDS158A – OCTOBER 2003 – REVISED DECEMBER 2004

simplified schematic, each FET switch (SW)



† Gate Voltage ( $V_G$ ) is approximately equal to  $V_{CC} + V_T$  when the switch is ON and  $V_I > V_{CC} + V_T$ .  
‡ EN is the internal enable signal applied to the switch.

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)§

|                                                                    |                |
|--------------------------------------------------------------------|----------------|
| Supply voltage range, $V_{CC}$ (see Note 1)                        | −0.5 V to 7 V  |
| Control input voltage range, $V_{IN}$ (see Notes 1 and 2)          | −0.5 V to 7 V  |
| Switch I/O voltage range, $V_{I/O}$ (see Notes 1, 2, and 3)        | −0.5 V to 7 V  |
| Control input clamp current, $I_{IK}$ ( $V_{IN} < 0$ )             | −50 mA         |
| I/O port clamp current, $I_{I/OK}$ ( $V_{I/O} < 0$ )               | −50 mA         |
| ON-state switch current, $I_{I/O}$ (see Note 4)                    | ±128 mA        |
| Continuous current through $V_{CC}$ or GND terminals               | ±100 mA        |
| Package thermal impedance, $\theta_{JA}$ (see Note 5): DBQ package | 61°C/W         |
| DGV package                                                        | 86°C/W         |
| DW package                                                         | 46°C/W         |
| PW package                                                         | 88°C/W         |
| Storage temperature range, $T_{stg}$                               | −65°C to 150°C |

§ Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES:
1. All voltages are with respect to ground unless otherwise specified.
  2. The input and output voltage ratings may be exceeded if the input and output clamp-current ratings are observed.
  3.  $V_I$  and  $V_O$  are used to denote specific conditions for  $V_{I/O}$ .
  4.  $I_I$  and  $I_O$  are used to denote specific conditions for  $I_{I/O}$ .
  5. The package thermal impedance is calculated in accordance with JESD 51-7.

recommended operating conditions (see Note 6)

|           |                                  | MIN                                     | MAX | UNIT |
|-----------|----------------------------------|-----------------------------------------|-----|------|
| $V_{CC}$  | Supply voltage                   | 2.3                                     | 3.6 | V    |
| $V_{IH}$  | High-level control input voltage | $V_{CC} = 2.3\text{ V to }2.7\text{ V}$ | 1.7 | 5.5  |
|           |                                  | $V_{CC} = 2.7\text{ V to }3.6\text{ V}$ | 2   | 5.5  |
| $V_{IL}$  | Low-level control input voltage  | $V_{CC} = 2.3\text{ V to }2.7\text{ V}$ | 0   | 0.7  |
|           |                                  | $V_{CC} = 2.7\text{ V to }3.6\text{ V}$ | 0   | 0.8  |
| $V_{I/O}$ | Data input/output voltage        | 0                                       | 5.5 | V    |
| $T_A$     | Operating free-air temperature   | −40                                     | 85  | °C   |

NOTE 6: All unused control inputs of the device must be held at  $V_{CC}$  or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.

**SN74CB3T3383**  
**10-BIT FET BUS-EXCHANGE SWITCH**  
**2.5-V/3.3-V LOW-VOLTAGE BUS SWITCH WITH 5-V-TOLERANT LEVEL SHIFTER**

SCDS158A – OCTOBER 2003 – REVISED DECEMBER 2004

**electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)**

| PARAMETER            |                | TEST CONDITIONS                                                                                                            | MIN                                            | TYP <sup>†</sup> | MAX      | UNIT          |
|----------------------|----------------|----------------------------------------------------------------------------------------------------------------------------|------------------------------------------------|------------------|----------|---------------|
| $V_{IK}$             |                | $V_{CC} = 3\text{ V}$ ,<br>$I_I = -18\text{ mA}$                                                                           |                                                |                  | -1.2     | V             |
| $V_{OH}$             |                | See Figures 3 and 4                                                                                                        |                                                |                  |          |               |
| $I_{IN}^{\ddagger}$  | Control inputs | $V_{CC} = 3.6\text{ V}$ ,<br>$V_{IN}^{\ddagger} = 3.6\text{ V to } 5.5\text{ V or GND}$                                    |                                                |                  | $\pm 10$ | $\mu\text{A}$ |
| $I_I$                |                | $V_{CC} = 3.6\text{ V}$ ,<br>Switch ON,<br>$V_{IN} = V_{CC}$ or GND                                                        | $V_I = V_{CC} - 0.7\text{ V to } 5.5\text{ V}$ |                  | $\pm 20$ | $\mu\text{A}$ |
|                      |                |                                                                                                                            | $V_I = 0.7\text{ V to } V_{CC} - 0.7\text{ V}$ |                  | -40      |               |
|                      |                |                                                                                                                            | $V_I = 0\text{ to } 0.7\text{ V}$              |                  | $\pm 5$  |               |
| $I_{OZ}^{\S}$        |                | $V_{CC} = 3.6\text{ V}$ ,<br>$V_O = 0\text{ to } 5.5\text{ V}$ ,<br>$V_I = 0$ ,<br>Switch OFF,<br>$V_{IN} = V_{CC}$ or GND |                                                |                  | $\pm 10$ | $\mu\text{A}$ |
| $I_{off}$            |                | $V_{CC} = 0$ ,<br>$V_O = 0\text{ to } 5.5\text{ V}$ ,<br>$V_I = 0$ ,                                                       |                                                |                  | 10       | $\mu\text{A}$ |
| $I_{CC}$             |                | $V_{CC} = 3.6\text{ V}$ ,<br>$I_{I/O} = 0$ ,<br>Switch ON or OFF,<br>$V_{IN} = V_{CC}$ or GND                              | $V_I = V_{CC}$ or GND                          |                  | 20       | $\mu\text{A}$ |
|                      |                |                                                                                                                            | $V_I = 5.5\text{ V}$                           |                  | 20       |               |
| $\Delta I_{CC}^{\P}$ | Control inputs | $V_{CC} = 3\text{ V to } 3.6\text{ V}$ ,<br>One input at $V_{CC} - 0.6\text{ V}$ ,<br>Other inputs at $V_{CC}$ or GND      |                                                |                  | 300      | $\mu\text{A}$ |
| $C_{in}$             | Control inputs | $V_{CC} = 3.3\text{ V}$ ,<br>$V_{IN} = V_{CC}$ or GND                                                                      |                                                |                  | 4        | pF            |
| $C_{io(OFF)}$        |                | $V_{CC} = 3.3\text{ V}$ ,<br>$V_{I/O} = 5.5\text{ V, } 3.3\text{ V, or GND}$ ,<br>Switch OFF,<br>$V_{IN} = V_{CC}$ or GND  |                                                |                  | 8        | pF            |
| $C_{io(ON)}$         |                | $V_{CC} = 3.3\text{ V}$ ,<br>Switch ON,<br>$V_{IN} = V_{CC}$ or GND                                                        | $V_{I/O} = 5.5\text{ V or } 3.3\text{ V}$      |                  | 7        | pF            |
|                      |                |                                                                                                                            | $V_{I/O} = \text{GND}$                         |                  | 21       |               |
| $r_{on}^{\#}$        |                | $V_{CC} = 2.3\text{ V}$ ,<br>TYP at $V_{CC} = 2.5\text{ V}$ ,<br>$V_I = 0$                                                 | $I_O = 24\text{ mA}$                           |                  | 5        | $\Omega$      |
|                      |                |                                                                                                                            | $I_O = 16\text{ mA}$                           |                  | 5        |               |
|                      |                | $V_{CC} = 3\text{ V}$ ,<br>$V_I = 0$                                                                                       | $I_O = 64\text{ mA}$                           |                  | 5        |               |
|                      |                |                                                                                                                            | $I_O = 32\text{ mA}$                           |                  | 5        |               |

<sup>†</sup> All typical values are at  $V_{CC} = 3.3\text{ V}$  (unless otherwise noted),  $T_A = 25^\circ\text{C}$ .

<sup>‡</sup>  $V_{IN}$  and  $I_{IN}$  refer to control inputs.  $V_I$ ,  $V_O$ ,  $I_I$ , and  $I_O$  refer to data pins.

<sup>§</sup> For I/O ports, the parameter  $I_{OZ}$  includes the input leakage current.

<sup>\P</sup> This is the increase in supply current for each input that is at the specified TTL voltage level, rather than  $V_{CC}$  or GND.

<sup>#</sup> Measured by the voltage drop between A and B terminals at the indicated current through the switch. ON-state resistance is determined by the lower of the voltages of the two (A or B) terminals.

**SN74CB3T3383**  
**10-BIT FET BUS-EXCHANGE SWITCH**  
**2.5-V/3.3-V LOW-VOLTAGE BUS SWITCH WITH 5-V-TOLERANT LEVEL SHIFTER**

SCDS158A – OCTOBER 2003 – REVISED DECEMBER 2004

switching characteristics over recommended operating free-air temperature range (unless otherwise noted) (see Figure 2)

| PARAMETER                    | FROM<br>(INPUT)        | TO<br>(OUTPUT) | V <sub>CC</sub> = 2.5 V<br>± 0.2 V |      | V <sub>CC</sub> = 3.3 V<br>± 0.3 V |     | UNIT |
|------------------------------|------------------------|----------------|------------------------------------|------|------------------------------------|-----|------|
|                              |                        |                | MIN                                | MAX  | MIN                                | MAX |      |
| t <sub>pd</sub> <sup>†</sup> | A or B                 | B or A         | 0.15                               |      | 0.25                               |     | ns   |
| t <sub>pd(s)</sub>           | BX                     | A or B         | 1                                  | 15   | 1                                  | 10  |      |
| t <sub>en</sub>              | $\overline{\text{BE}}$ | A or B         | 1                                  | 13.5 | 1                                  | 9   | ns   |
| t <sub>dis</sub>             | $\overline{\text{BE}}$ | A or B         | 1                                  | 7    | 1                                  | 8.5 | ns   |

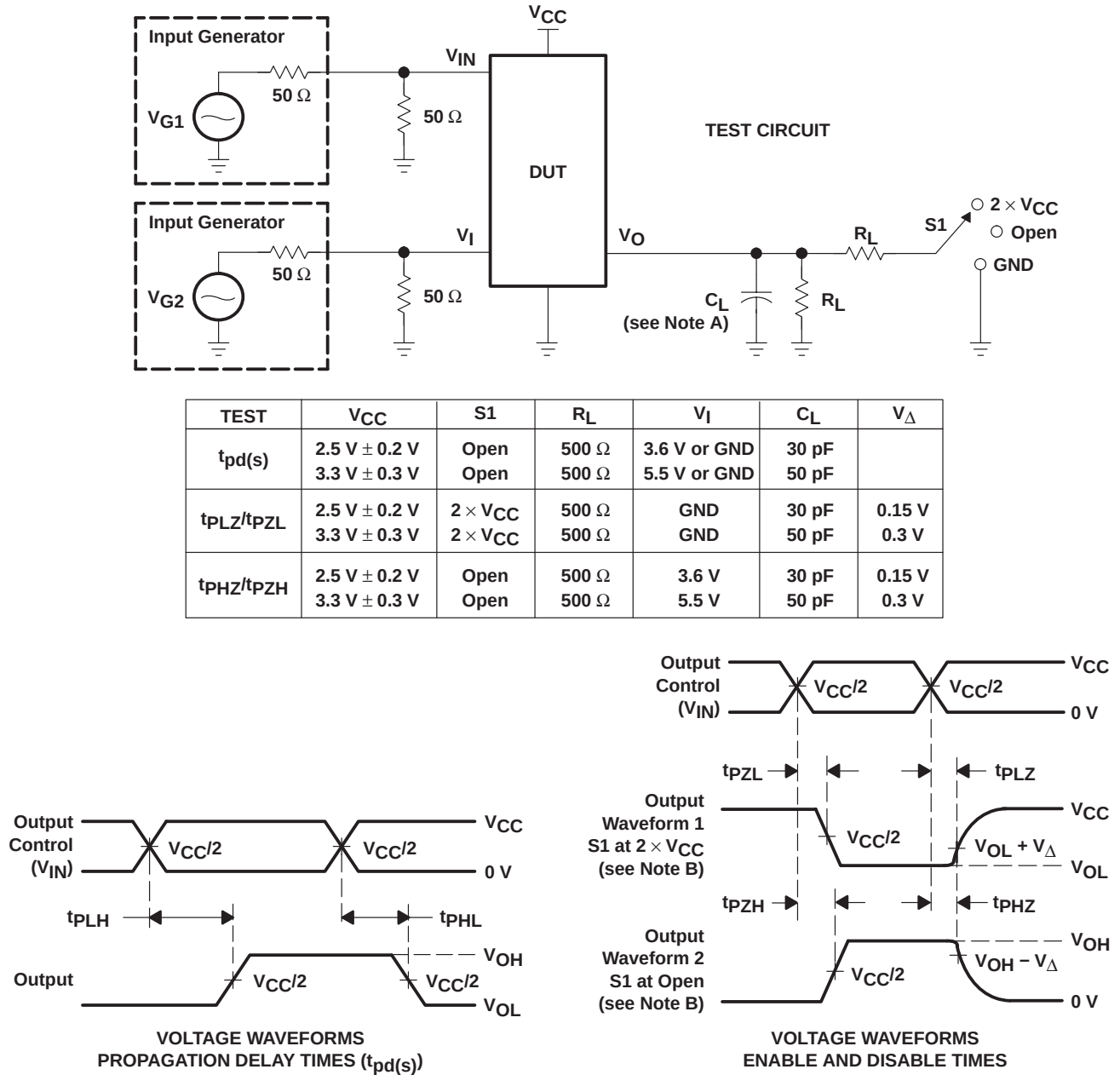
<sup>†</sup> The propagation delay is the calculated RC time constant of the typical ON-state resistance of the switch and the specified load capacitance, when driven by an ideal voltage source (zero output impedance).



**SN74CB3T3383**  
**10-BIT FET BUS-EXCHANGE SWITCH**  
**2.5-V/3.3-V LOW-VOLTAGE BUS SWITCH WITH 5-V-TOLERANT LEVEL SHIFTER**

SCDS158A – OCTOBER 2003 – REVISED DECEMBER 2004

**PARAMETER MEASUREMENT INFORMATION**



- NOTES:
- A. C<sub>L</sub> includes probe and jig capacitance.
  - B. Waveform 1 is for an output with internal conditions such that the output is low, except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control.
  - C. All input pulses are supplied by generators having the following characteristics: PRR ≤ 10 MHz, Z<sub>O</sub> = 50 Ω, t<sub>r</sub> ≤ 2.5 ns, t<sub>f</sub> ≤ 2.5 ns.
  - D. The outputs are measured one at a time, with one transition per measurement.
  - E. t<sub>PLZ</sub> and t<sub>PHZ</sub> are the same as t<sub>dis</sub>.
  - F. t<sub>PZL</sub> and t<sub>PZH</sub> are the same as t<sub>en</sub>.
  - G. t<sub>PLH</sub> and t<sub>PHL</sub> are the same as t<sub>pd</sub>(s). The t<sub>pd</sub> propagation delay is the calculated RC time constant of the typical ON-state resistance of the switch and the specified load capacitance, when driven by an ideal voltage source (zero output impedance).
  - H. All parameters and waveforms are not applicable to all devices.

**Figure 2. Test Circuit and Voltage Waveforms**

## TYPICAL CHARACTERISTICS

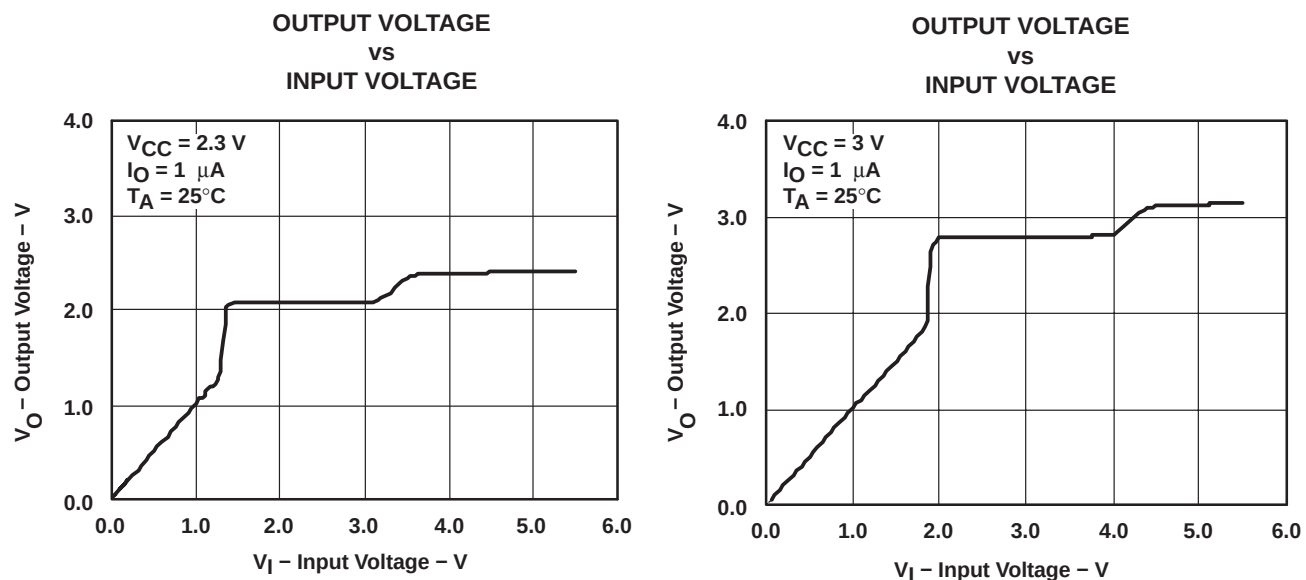


Figure 3. Data Output Voltage vs Data Input Voltage

**SN74CB3T3383**  
**10-BIT FET BUS-EXCHANGE SWITCH**  
**2.5-V/3.3-V LOW-VOLTAGE BUS SWITCH WITH 5-V-TOLERANT LEVEL SHIFTER**

SCDS158A – OCTOBER 2003 – REVISED DECEMBER 2004

**TYPICAL CHARACTERISTICS (continued)**

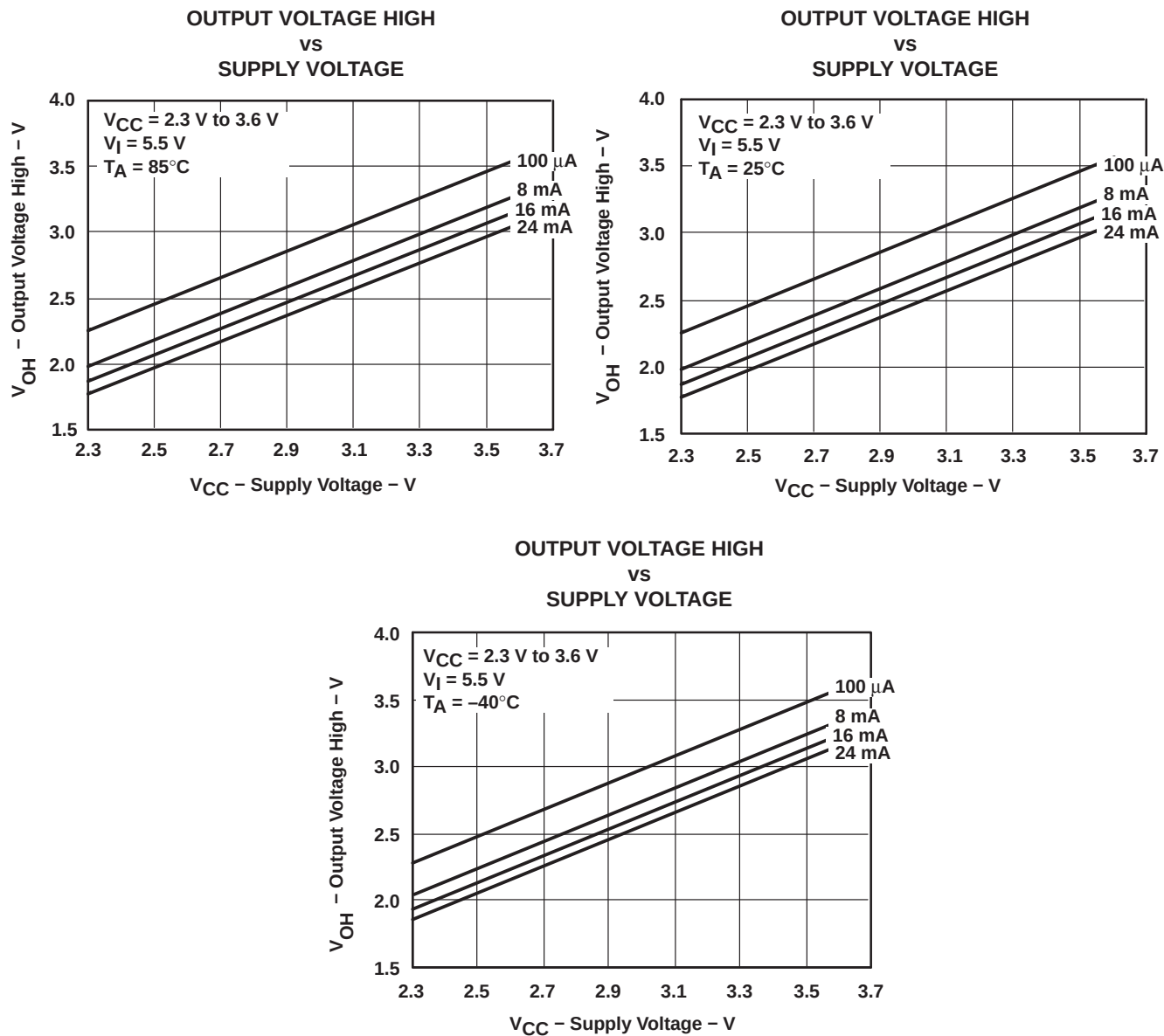


**Figure 4.  $V_{OH}$  Values**

## PACKAGING INFORMATION

| Orderable part number            | Status<br>(1) | Material type<br>(2) | Package   Pins   | Package qty   Carrier | RoHS<br>(3) | Lead finish/<br>Ball material<br>(4) | MSL rating/<br>Peak reflow<br>(5) | Op temp (°C) | Part marking<br>(6) |
|----------------------------------|---------------|----------------------|------------------|-----------------------|-------------|--------------------------------------|-----------------------------------|--------------|---------------------|
| <a href="#">SN74CB3T3383DGVR</a> | Active        | Production           | TVSOP (DGV)   24 | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | KS383               |
| SN74CB3T3383DGVR.B               | Active        | Production           | TVSOP (DGV)   24 | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | KS383               |
| <a href="#">SN74CB3T3383DWR</a>  | Active        | Production           | SOIC (DW)   24   | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | CB3T3383            |
| SN74CB3T3383DWR.B                | Active        | Production           | SOIC (DW)   24   | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | CB3T3383            |
| <a href="#">SN74CB3T3383PW</a>   | Active        | Production           | TSSOP (PW)   24  | 60   TUBE             | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | KS383               |
| SN74CB3T3383PW.B                 | Active        | Production           | TSSOP (PW)   24  | 60   TUBE             | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | KS383               |
| <a href="#">SN74CB3T3383PWR</a>  | Active        | Production           | TSSOP (PW)   24  | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | KS383               |
| SN74CB3T3383PWR.B                | Active        | Production           | TSSOP (PW)   24  | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | KS383               |
| SN74CB3T3383PWRG4.B              | Active        | Production           | TSSOP (PW)   24  | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | KS383               |

<sup>(1)</sup> **Status:** For more details on status, see our [product life cycle](#).

<sup>(2)</sup> **Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

<sup>(3)</sup> **RoHS values:** Yes, No, RoHS Exempt. See the [TI RoHS Statement](#) for additional information and value definition.

<sup>(4)</sup> **Lead finish/Ball material:** Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

<sup>(5)</sup> **MSL rating/Peak reflow:** The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

<sup>(6)</sup> **Part marking:** There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

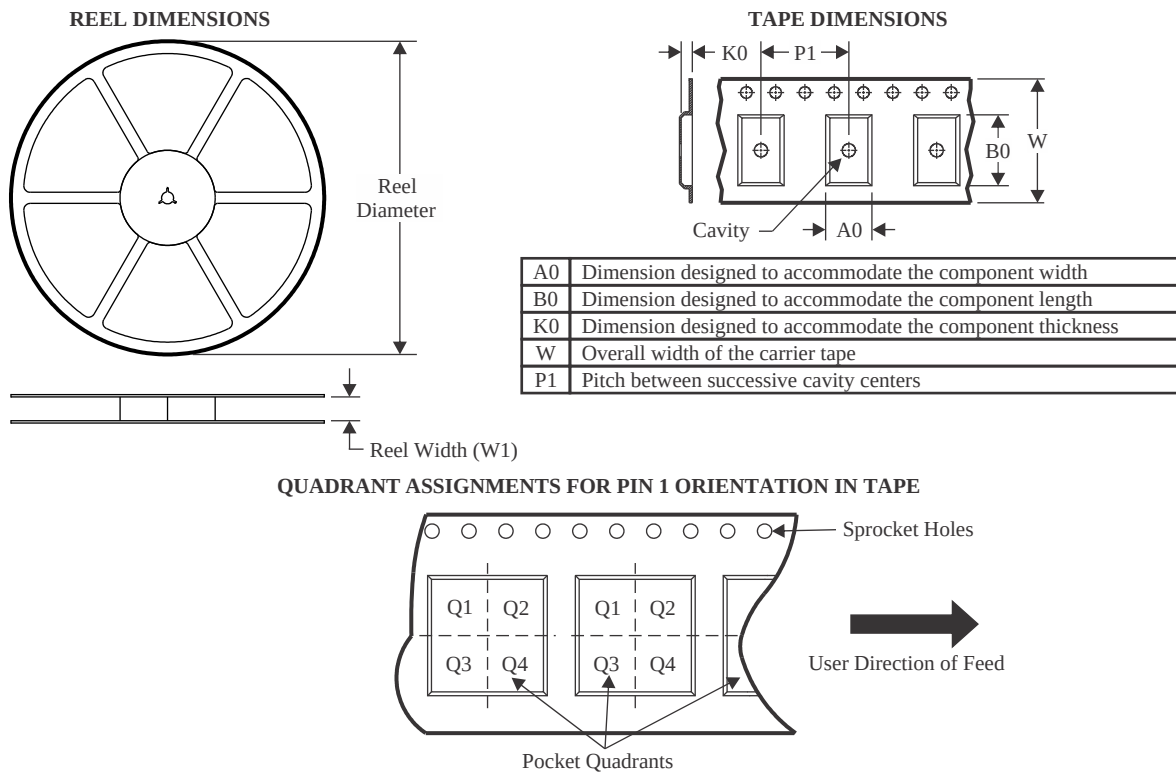
Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

**Important Information and Disclaimer:** The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative

and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

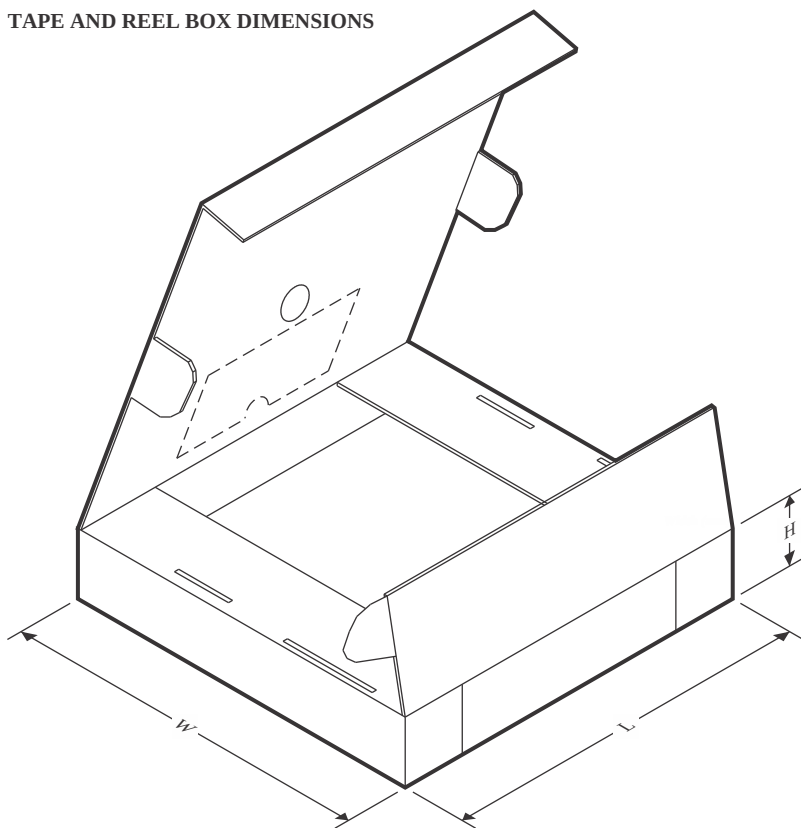
## TAPE AND REEL INFORMATION



\*All dimensions are nominal

| Device           | Package Type | Package Drawing | Pins | SPQ  | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|------------------|--------------|-----------------|------|------|--------------------|--------------------|---------|---------|---------|---------|--------|---------------|
| SN74CB3T3383DGVR | TVSOP        | DGV             | 24   | 2000 | 330.0              | 12.4               | 6.9     | 5.6     | 1.6     | 8.0     | 12.0   | Q1            |
| SN74CB3T3383DWR  | SOIC         | DW              | 24   | 2000 | 330.0              | 24.4               | 10.75   | 15.7    | 2.7     | 12.0    | 24.0   | Q1            |
| SN74CB3T3383PWR  | TSSOP        | PW              | 24   | 2000 | 330.0              | 16.4               | 6.95    | 8.3     | 1.6     | 8.0     | 16.0   | Q1            |

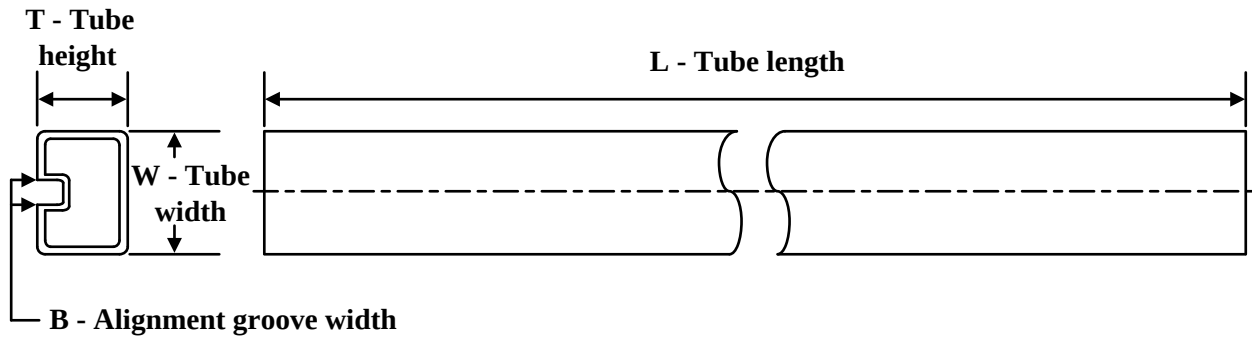
## TAPE AND REEL BOX DIMENSIONS



\*All dimensions are nominal

| Device           | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|------------------|--------------|-----------------|------|------|-------------|------------|-------------|
| SN74CB3T3383DGVR | TVSOP        | DGV             | 24   | 2000 | 367.0       | 367.0      | 35.0        |
| SN74CB3T3383DWR  | SOIC         | DW              | 24   | 2000 | 350.0       | 350.0      | 43.0        |
| SN74CB3T3383PWR  | TSSOP        | PW              | 24   | 2000 | 356.0       | 356.0      | 35.0        |

## TUBE

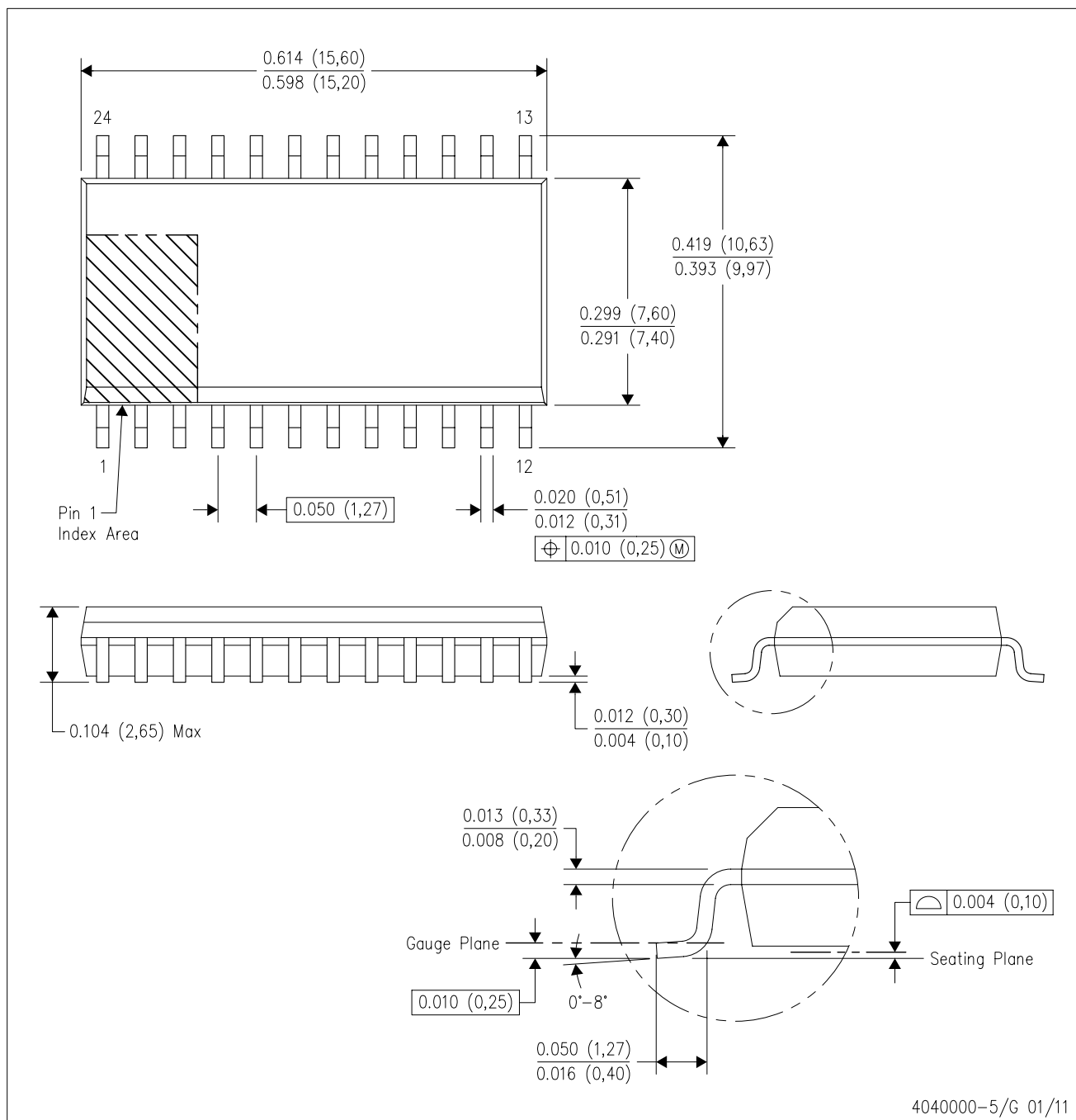


\*All dimensions are nominal

| Device           | Package Name | Package Type | Pins | SPQ | L (mm) | W (mm) | T (μm) | B (mm) |
|------------------|--------------|--------------|------|-----|--------|--------|--------|--------|
| SN74CB3T3383PW   | PW           | TSSOP        | 24   | 60  | 530    | 10.2   | 3600   | 3.5    |
| SN74CB3T3383PW.B | PW           | TSSOP        | 24   | 60  | 530    | 10.2   | 3600   | 3.5    |

DW (R-PDSO-G24)

PLASTIC SMALL OUTLINE



- NOTES:
- A. All linear dimensions are in inches (millimeters). Dimensioning and tolerancing per ASME Y14.5M-1994.
  - B. This drawing is subject to change without notice.
  - C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).
  - D. Falls within JEDEC MS-013 variation AD.

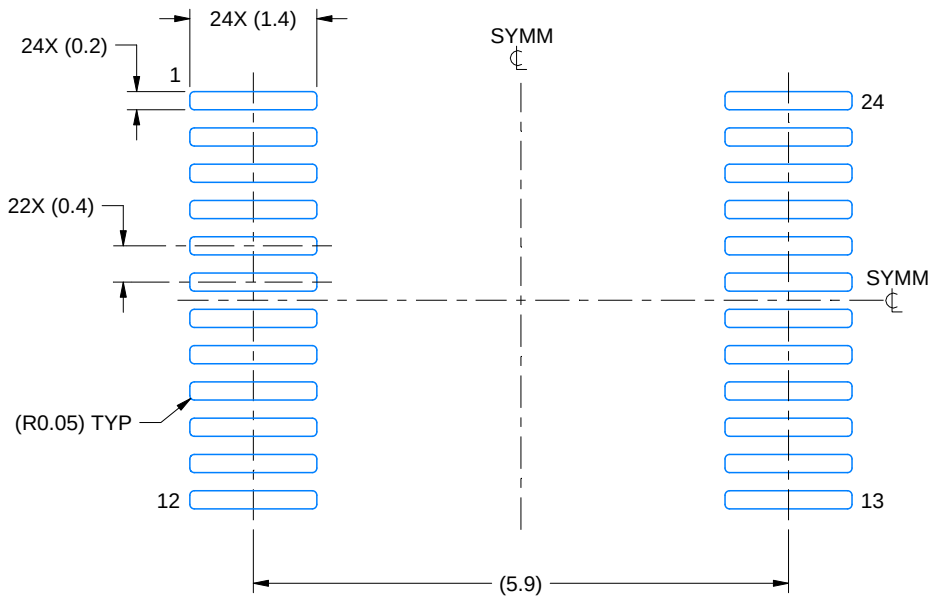


# EXAMPLE BOARD LAYOUT

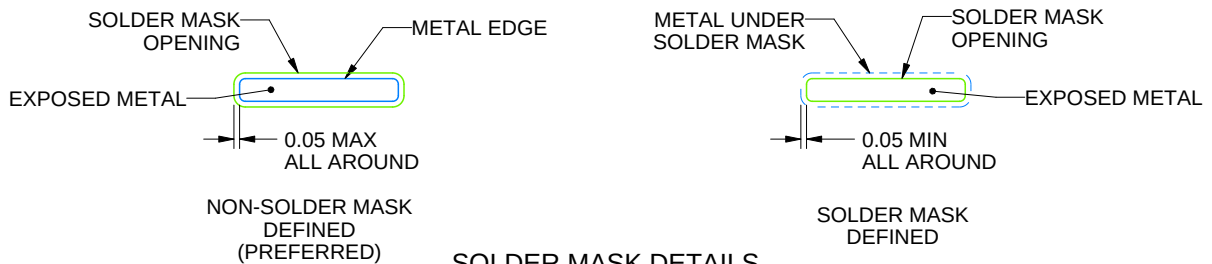
DGV0024A

TVSOP - 1.2 mm max height

SMALL OUTLINE PACKAGE



LAND PATTERN EXAMPLE  
EXPOSED METAL SHOWN  
SCALE: 12X



SOLDER MASK DETAILS

4229221/A 12/2022

NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.

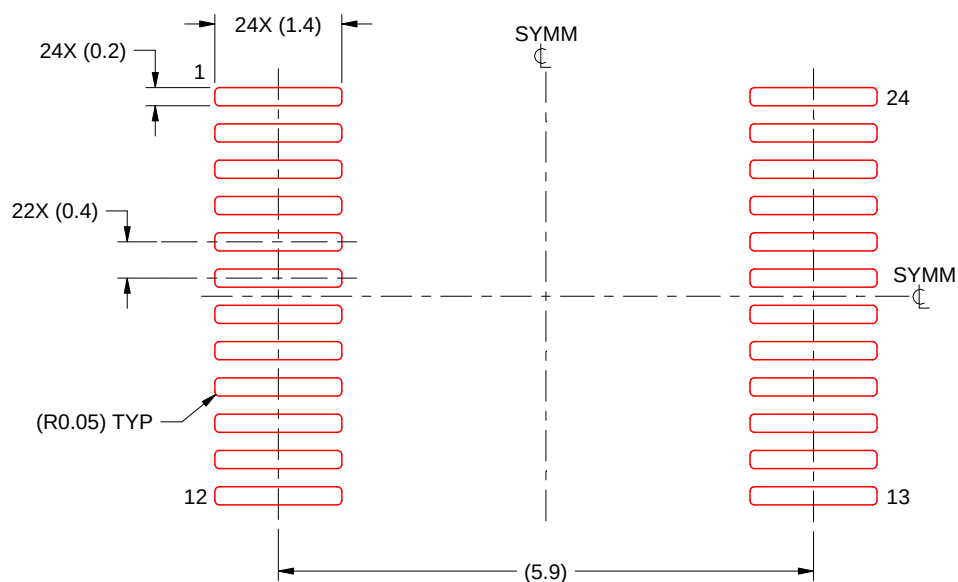
7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

## EXAMPLE STENCIL DESIGN

DGV0024A

TVSOP - 1.2 mm max height

SMALL OUTLINE PACKAGE



SOLDER PASTE EXAMPLE  
BASED ON 0.125 mm THICK STENCIL  
SCALE: 12X

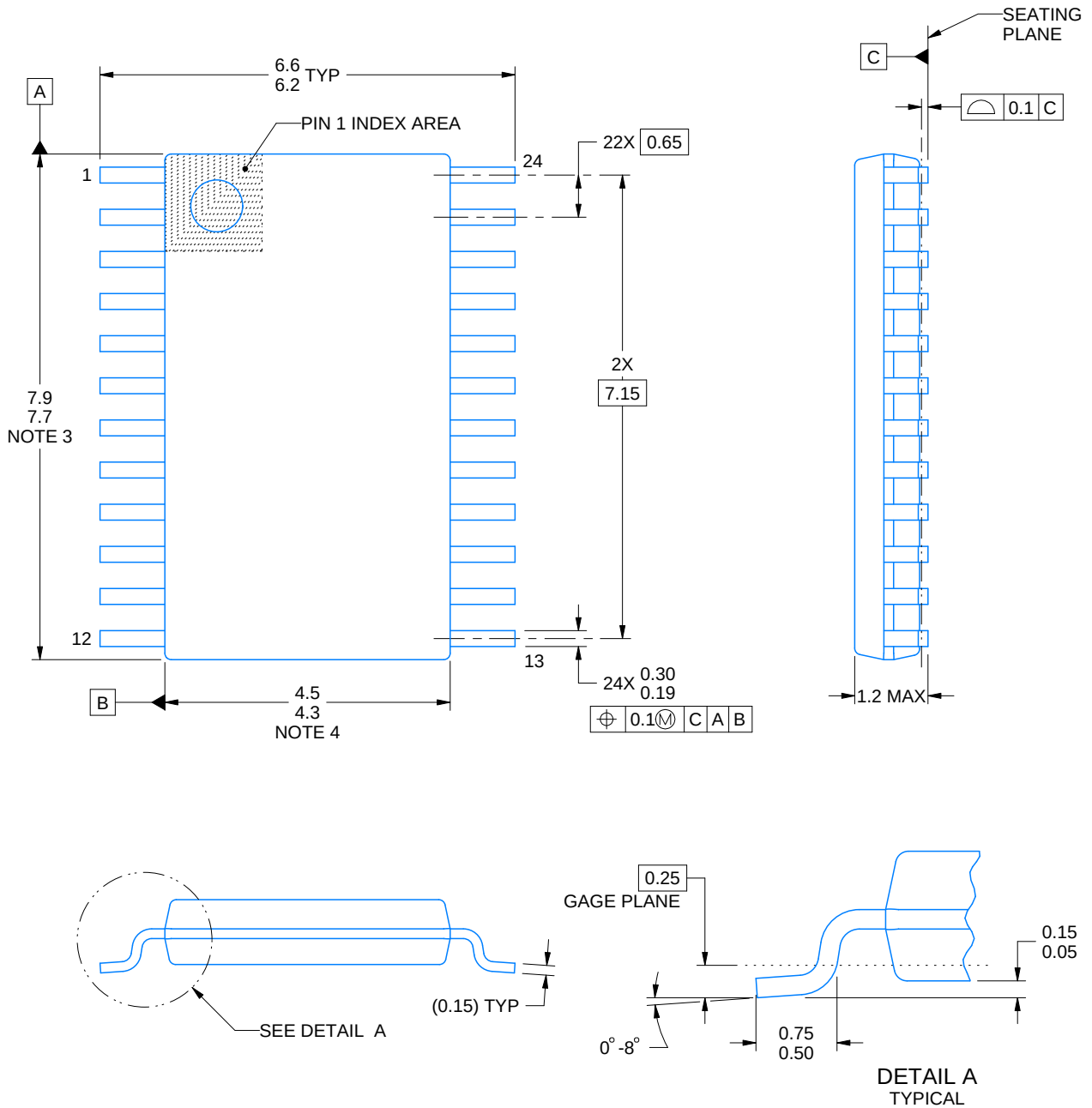
4229221/A 12/2022

NOTES: (continued)

8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
9. Board assembly site may have different recommendations for stencil design.



## TSSOP - 1.2 mm max height

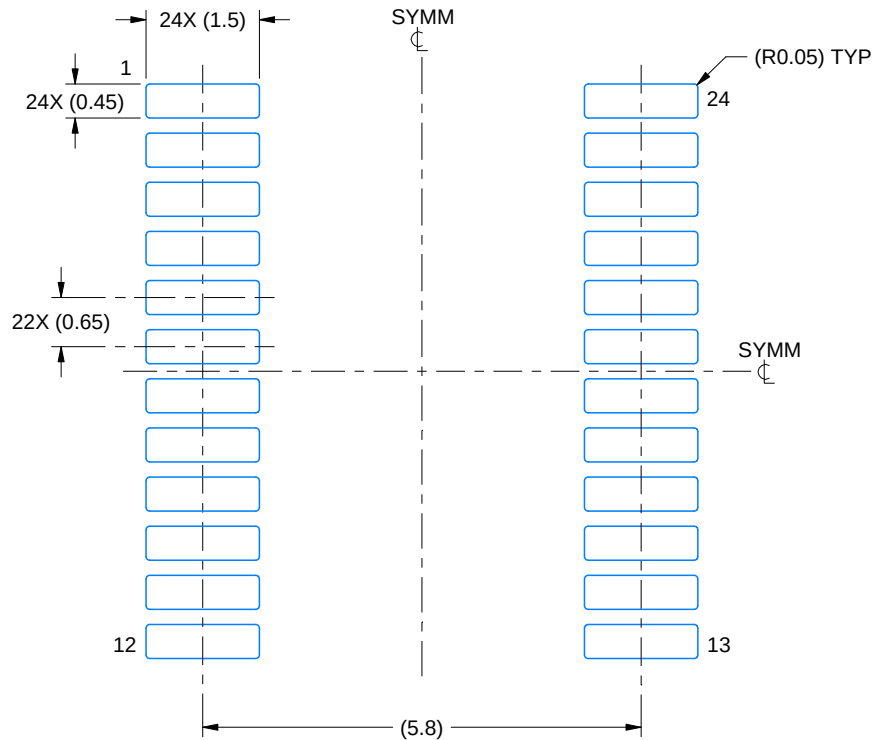


# EXAMPLE BOARD LAYOUT

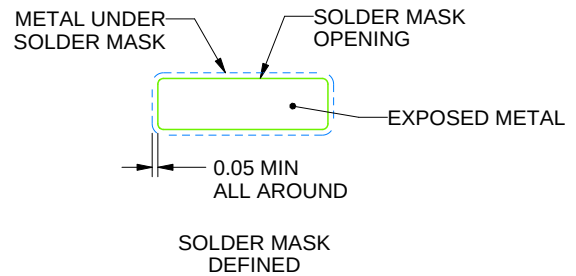
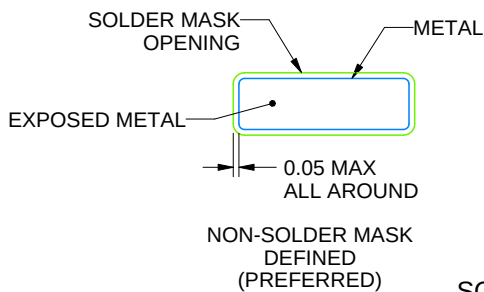
PW0024A

TSSOP - 1.2 mm max height

SMALL OUTLINE PACKAGE



LAND PATTERN EXAMPLE  
EXPOSED METAL SHOWN  
SCALE: 10X



SOLDER MASK DETAILS

4220208/A 02/2017

NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.

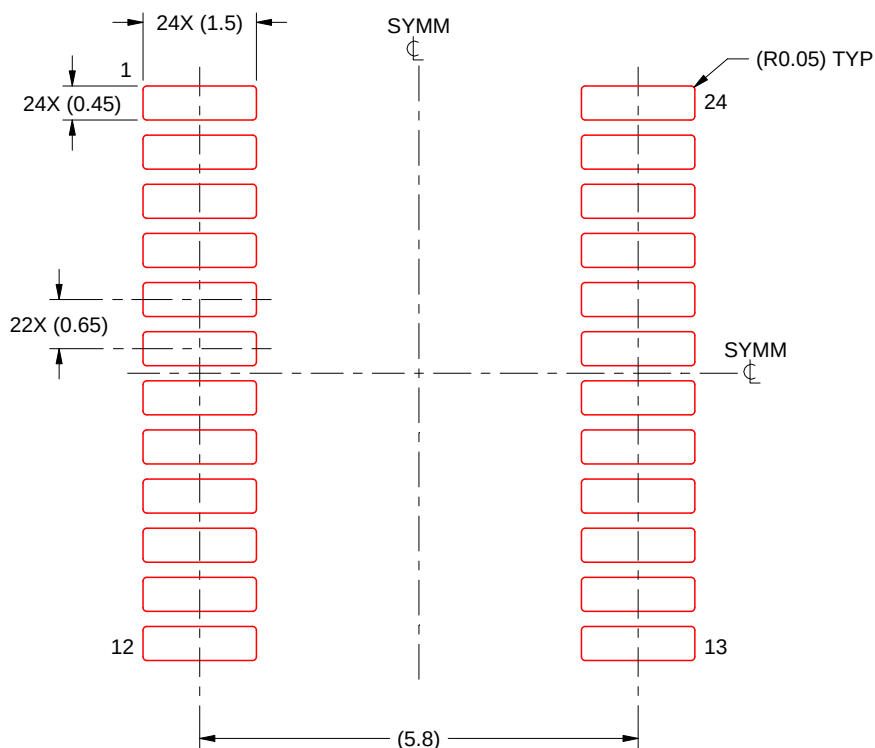
7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

# EXAMPLE STENCIL DESIGN

PW0024A

TSSOP - 1.2 mm max height

SMALL OUTLINE PACKAGE



SOLDER PASTE EXAMPLE  
BASED ON 0.125 mm THICK STENCIL  
SCALE: 10X

4220208/A 02/2017

NOTES: (continued)

8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
9. Board assembly site may have different recommendations for stencil design.

## IMPORTANT NOTICE AND DISCLAIMER

TI PROVIDES TECHNICAL AND RELIABILITY DATA (INCLUDING DATA SHEETS), DESIGN RESOURCES (INCLUDING REFERENCE DESIGNS), APPLICATION OR OTHER DESIGN ADVICE, WEB TOOLS, SAFETY INFORMATION, AND OTHER RESOURCES "AS IS" AND WITH ALL FAULTS, AND DISCLAIMS ALL WARRANTIES, EXPRESS AND IMPLIED, INCLUDING WITHOUT LIMITATION ANY IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE OR NON-INFRINGEMENT OF THIRD PARTY INTELLECTUAL PROPERTY RIGHTS.

These resources are intended for skilled developers designing with TI products. You are solely responsible for (1) selecting the appropriate TI products for your application, (2) designing, validating and testing your application, and (3) ensuring your application meets applicable standards, and any other safety, security, regulatory or other requirements.

These resources are subject to change without notice. TI grants you permission to use these resources only for development of an application that uses the TI products described in the resource. Other reproduction and display of these resources is prohibited. No license is granted to any other TI intellectual property right or to any third party intellectual property right. TI disclaims responsibility for, and you will fully indemnify TI and its representatives against, any claims, damages, costs, losses, and liabilities arising out of your use of these resources.

TI's products are provided subject to [TI's Terms of Sale](#) or other applicable terms available either on [ti.com](https://www.ti.com) or provided in conjunction with such TI products. TI's provision of these resources does not expand or otherwise alter TI's applicable warranties or warranty disclaimers for TI products.

TI objects to and rejects any additional or different terms you may have proposed.

Mailing Address: Texas Instruments, Post Office Box 655303, Dallas, Texas 75265  
Copyright © 2025, Texas Instruments Incorporated